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LXA03D530

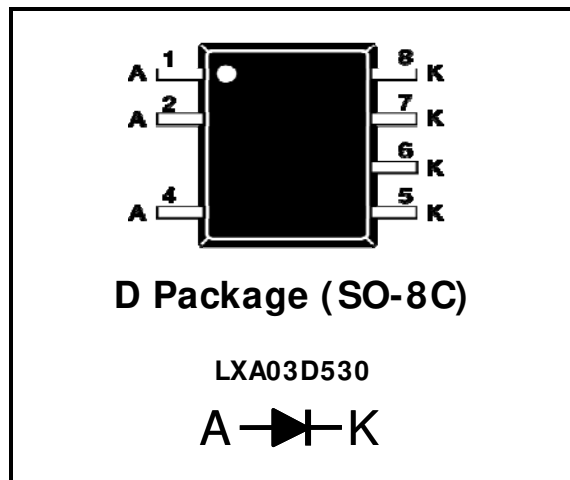
Qspeed™ Family

530 V, 3 A X-Series Diode

Product Summary

| | | |
|------------------------------------|------|----|
| $I_{F(AVG)}$ | 3 | A |
| V_{RRM} | 530 | V |
| Q_{RR} (Typ at 125 °C) | 75 | nC |
| I_{RRM} (Typ at 125 °C) | 3.2 | A |
| Softness t_B/t_A (Typ at 125 °C) | 0.34 | |

Pin Assignment



RoHS Compliant

Package uses lead-free plating and green mold compound.
Halogen-free per IEC 61249-2-21.

General Description

This device is an extremely low reverse recovery 530 V silicon diode. Its recovery characteristics increase efficiency, reduce EMI and eliminate snubbers.

Applications

- High-voltage power rectifier
- Power factor correction (PFC) boost diode
- Motor drive circuits
- DC-AC inverters

Features

- Low Q_{RR} , low I_{RRM} , low t_{RR}
- High dI_F/dt capable
- Soft recovery

Benefits

- Reduces peak reverse voltage
- Increases efficiency
 - Eliminates need for snubber circuits
 - Reduces EMI filter component size & count
- Enables extremely fast switching

Absolute Maximum Ratings

Absolute maximum ratings are the values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

| Symbol | Parameter | Conditions | Rating | Units |
|--------------|-----------------------------------|---|------------|-------|
| V_{RRM} | Peak repetitive reverse voltage | $T_J = 25\text{ °C}$ | 530 | V |
| $I_{F(AVG)}$ | Average forward current | $T_J = 150\text{ °C}, T_L = 29\text{ °C}$ | 3 | A |
| I_{FSM} | Non-repetitive peak surge current | 60 Hz, $\frac{1}{2}$ cycle, $T_C = 25\text{ °C}$ | 25 | A |
| I_{FSM} | Non-repetitive peak surge current | $\frac{1}{2}$ cycle of $t = 28\text{ }\mu\text{s}$ Sinusoid, $T_C = 25\text{ °C}$ | 350 | A |
| $T_{J(MAX)}$ | Maximum junction temperature | | 150 | °C |
| T_{STG} | Storage temperature | | -55 to 150 | °C |
| P_D | Power dissipation | $T_L = 25\text{ °C}$ | 4.6 | W |

Thermal Resistance

| Symbol | Resistance | Conditions | Rating | Units |
|-----------------|---------------------|---|--------|-------|
| $R_{\theta JA}$ | Junction to ambient | Soldered to 1 sq. in. (645 mm ²), 2 oz. Cu. | 80 | °C/W |
| $R_{\theta JL}$ | Junction to lead | Lead temperature measured on pin 7 | 27 | °C/W |

Electrical Specifications at $T_J = 25\text{ }^\circ\text{C}$ (unless otherwise specified)

| Symbol | Parameter | Conditions | Min | Typ | Max | Units | |
|--------------------------------|-------------------------------------|--|-----------------------------------|-------|------|---------------|----|
| DC Characteristics | | | | | | | |
| I_R | Reverse current | $V_R = 530\text{ V}, T_J = 25\text{ }^\circ\text{C}$ | - | 0.4 | 250 | μA | |
| | | $V_R = 530\text{ V}, T_J = 125\text{ }^\circ\text{C}$ | - | 0.275 | - | mA | |
| V_F | Forward voltage | $I_F = 3\text{ A}, T_J = 25\text{ }^\circ\text{C}$ | - | 1.55 | 1.71 | V | |
| | | $I_F = 3\text{ A}, T_J = 150\text{ }^\circ\text{C}$ | - | 1.33 | - | V | |
| C_J | Junction capacitance | $V_R = 10\text{ V}, 1\text{ MHz}$ | - | 15 | - | pF | |
| Dynamic Characteristics | | | | | | | |
| t_{RR} | Reverse recovery time | $di/dt = 200\text{ A}/\mu\text{s}$ $V_R = 400\text{ V}, I_F = 3\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | - | 25 | 34.3 | ns |
| | | | $T_J = 125\text{ }^\circ\text{C}$ | - | 33 | - | ns |
| Q_{RR} | Reverse recovery charge | $di/dt = 200\text{ A}/\mu\text{s}$ $V_R = 400\text{ V}, I_F = 3\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | - | 39 | 55 | nC |
| | | | $T_J = 125\text{ }^\circ\text{C}$ | - | 75 | - | nC |
| I_{RRM} | Maximum reverse recovery current | $di/dt = 200\text{ A}/\mu\text{s}$ $V_R = 400\text{ V}, I_F = 3\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | - | 2.2 | - | A |
| | | | $T_J = 125\text{ }^\circ\text{C}$ | - | 3.2 | - | A |
| S | Softness factor = $\frac{t_B}{t_A}$ | $di/dt = 200\text{ A}/\mu\text{s}$ $V_R = 400\text{ V}, I_F = 3\text{ A}$ | $T_J = 25\text{ }^\circ\text{C}$ | - | 0.7 | - | |
| | | | $T_J = 125\text{ }^\circ\text{C}$ | - | 0.34 | - | |

Note to component engineers: X-Series diodes employ Schottky technologies in their design and construction. Therefore, component engineers should plan their test setups to be similar to those for traditional Schottky test set-ups. (For additional details, see Application Note AN-300.)

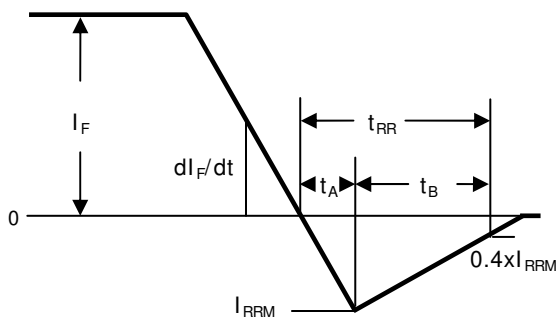


Figure 1. Reverse Recovery Definitions.

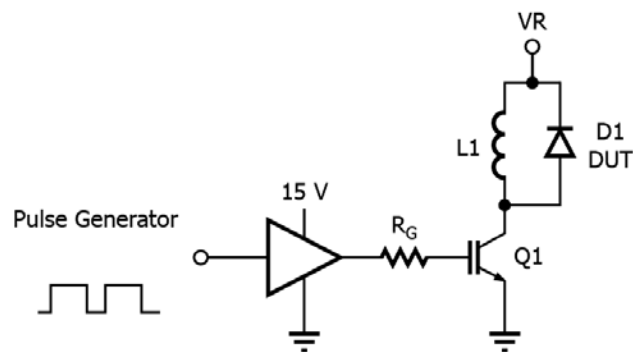


Figure 2. Reverse Recovery Test Circuit.

PI-7614-041315

Electrical Specifications at $T_J = 25\text{ }^\circ\text{C}$ (unless otherwise specified)

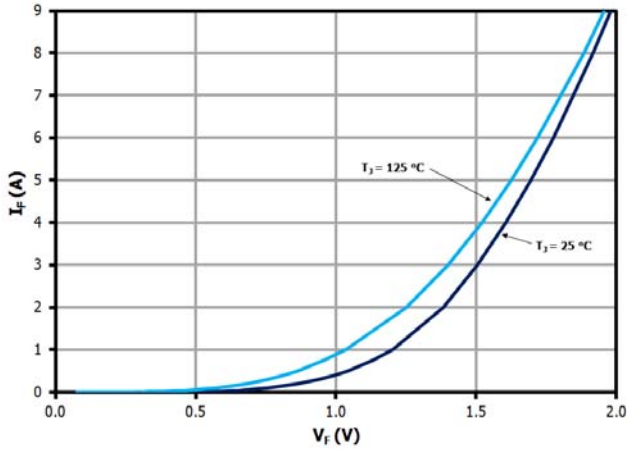


Figure 3. Typical I_F vs. V_F .

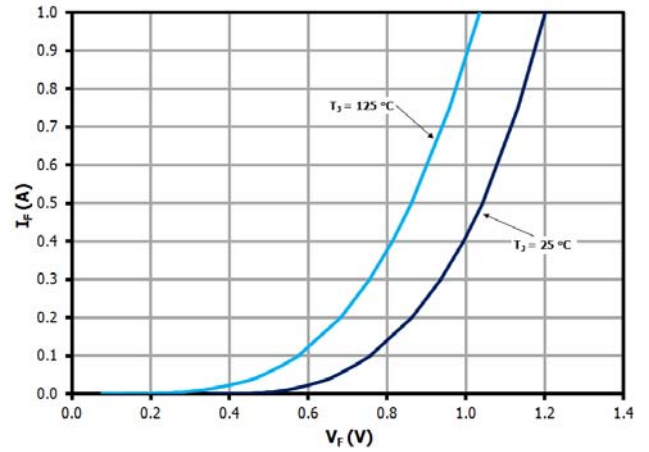


Figure 4. Typical I_F vs. V_F .

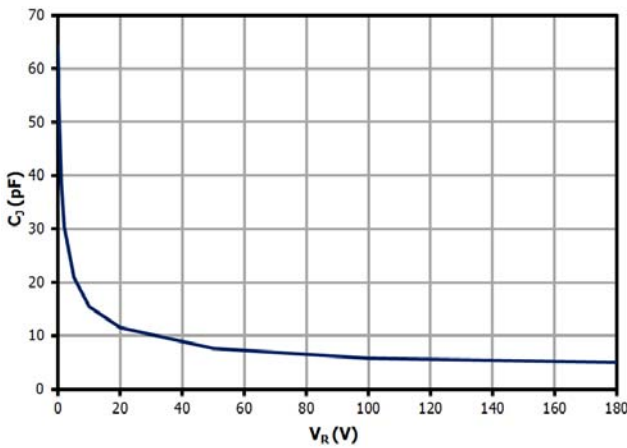


Figure 5. Typical C_J vs. V_R .

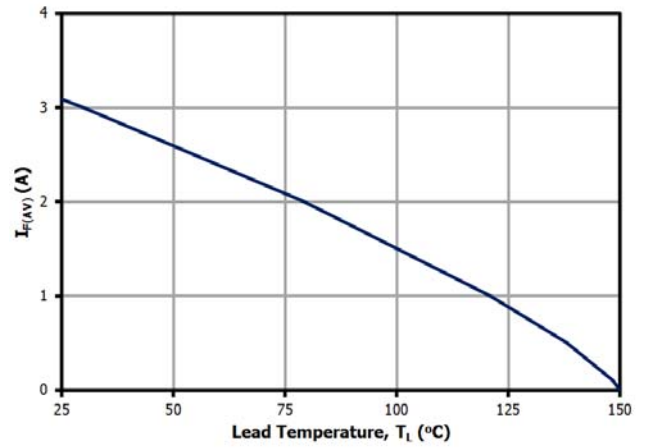


Figure 6. DC Current Derating Curve.

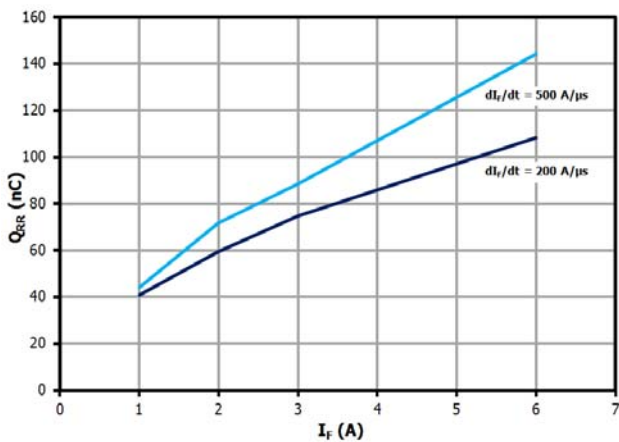


Figure 7. Typical Q_{RR} vs. I_F at $T_J = 125\text{ }^\circ\text{C}$.

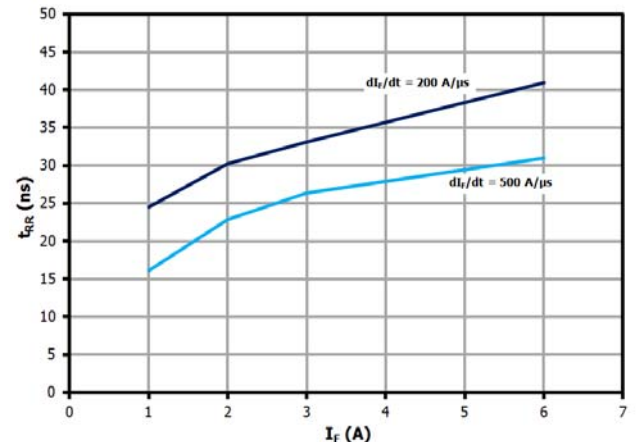


Figure 8. Typical t_{RR} vs. I_F at $T_J = 125\text{ }^\circ\text{C}$.

Electrical Specifications at $T_J = 25\text{ }^\circ\text{C}$ (unless otherwise specified)

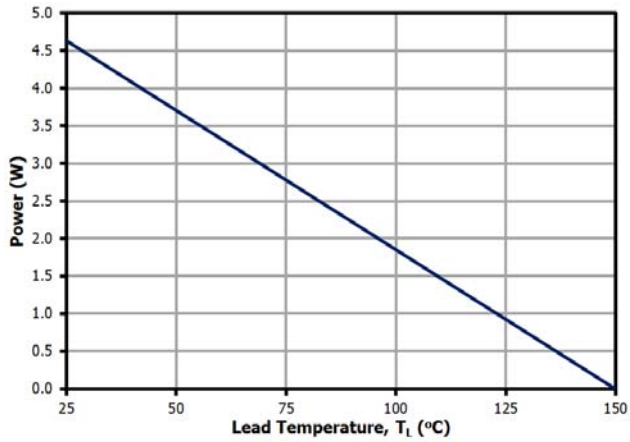


Figure 9. Power Derating Curve.

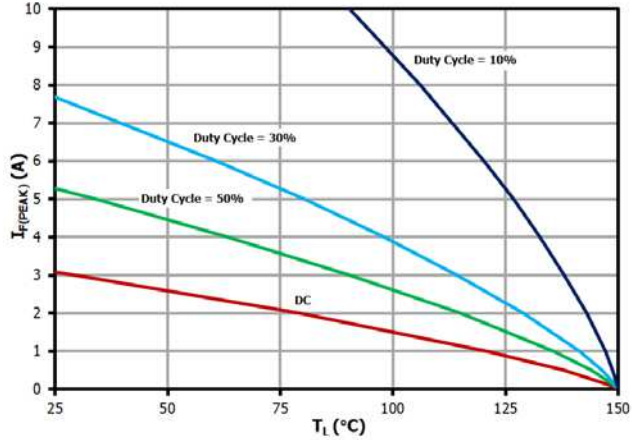


Figure 10. I_F (Peak) vs. T_L , $f = 70\text{ kHz}$.

LXA03D530

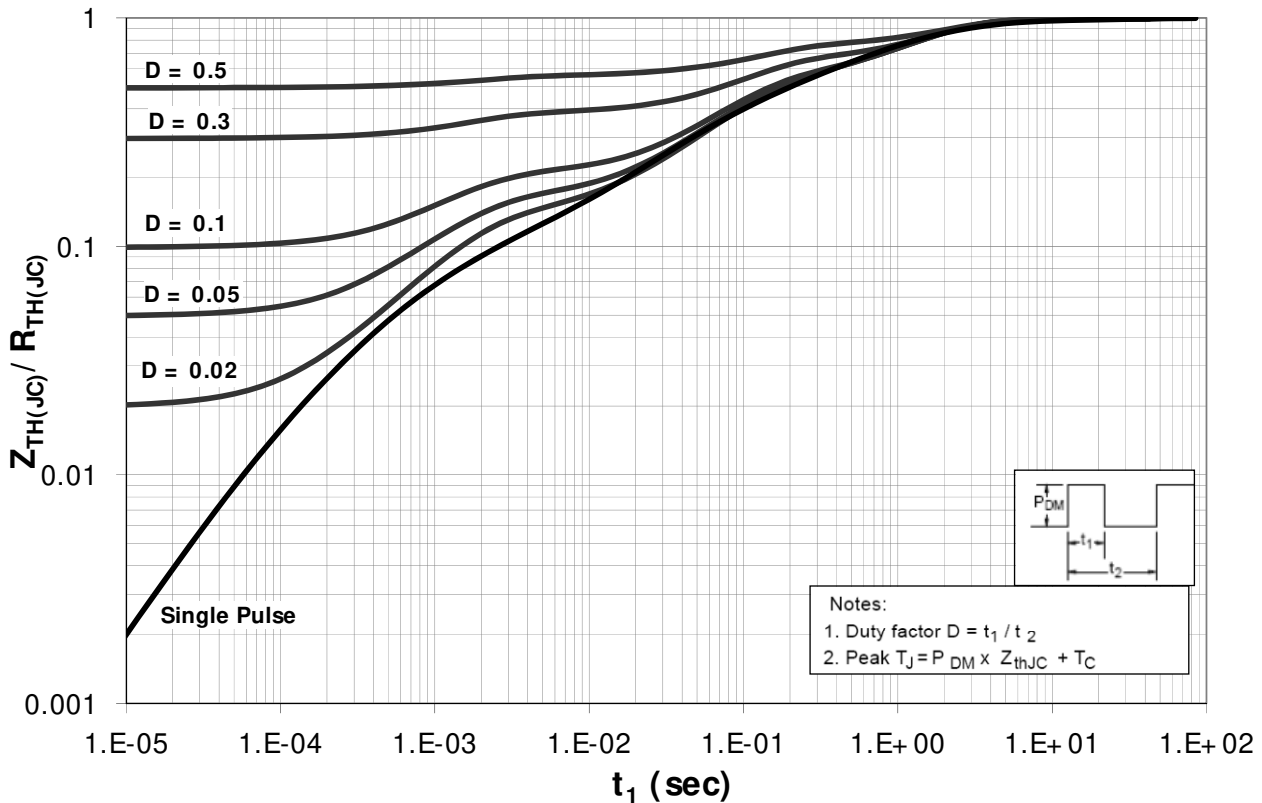
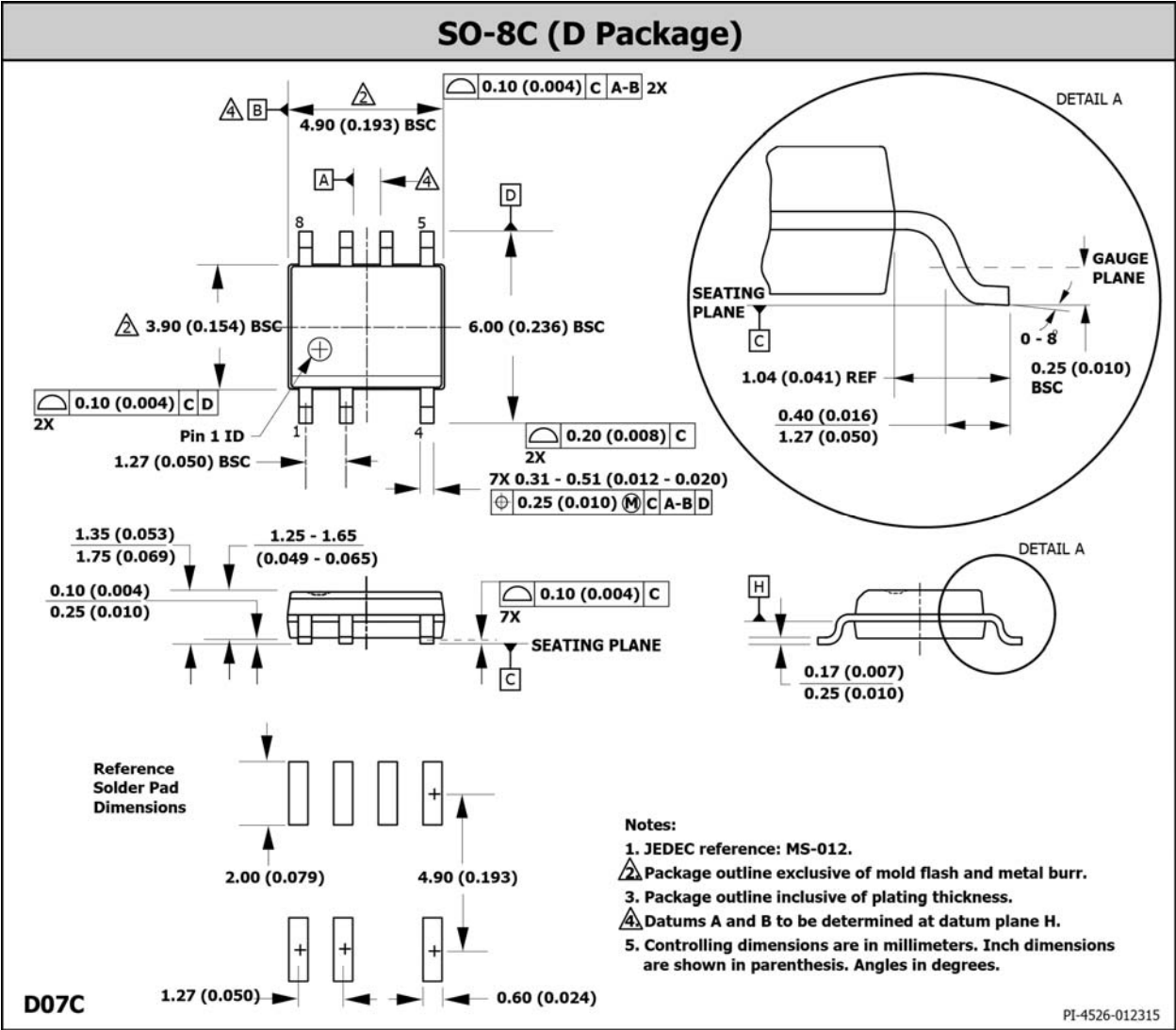


Figure 11. Normalized Maximum Transient Thermal Impedance.



Ordering Information

| Part Number | Package | Packing |
|-------------|---------|-----------------|
| LXA03D530 | SO-8C | 2500 units/reel |

The information contained in this document is subject to change without notice.

| Revision | Notes | Date |
|----------|------------------|-------|
| 1.0 | Initial Release. | 04/15 |

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